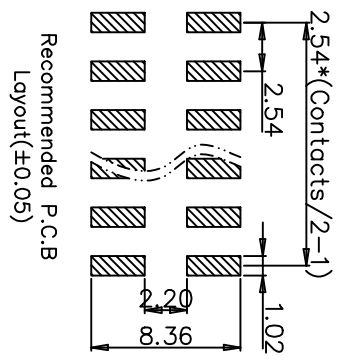
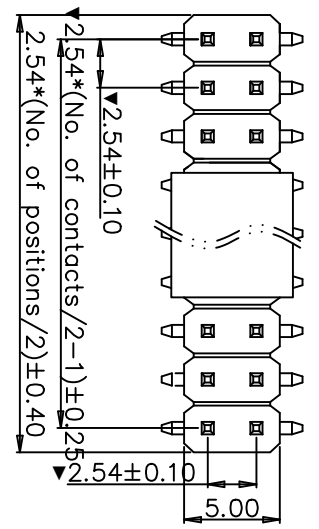


CUSTOMER COPY

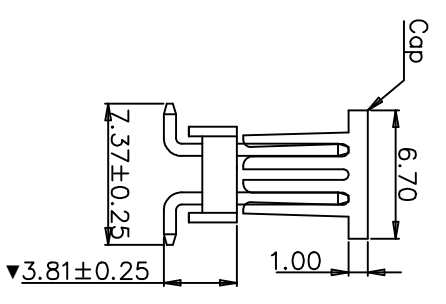
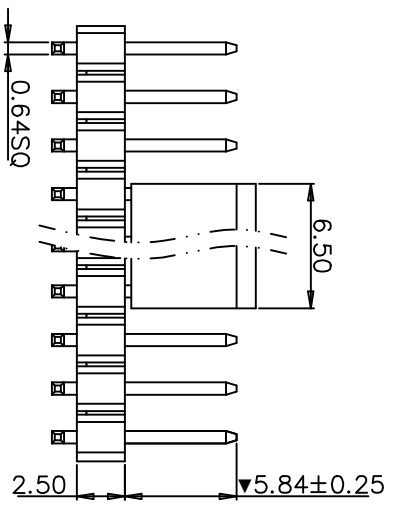


REVISION DATA				
SYM	ECN	DESCRIPTION	DATE	APPROVED



Technical Data
 Contact: brass (H65)
 Contact plating: see ordering information
 Insulator: black PA9T UL94V-0

Current rating: 3Amps
 Contact resistance: 20mΩ max.
 Insulation resistance: 1000MΩ min. at 100V
 Withstanding Voltage: 550V AC/minute
 Retention force: 0.8kgf/contact per layer min.
 Operating temperature: -40°C to +105°C
 Soldering temperature: 260°C±5° 5S
 Critical Dimensions: ▼



Ordering information

QHD2 25 1 - P XX X X C 369

High Option
25: H=2.50mm

No. of Positions
04-80

Plating Option
A: GF
B: Au3μ"
C: Au5μ"
D: Au10μ"
S: Sn120μ"
Z: Special (Underline option is standard)

Insulator Material Option
F: BK-LCP
G: BK-PA9T
Special (Underline option is standard)

Serial No.
01-99

Packing		TOLERANCE: ±2°		PROJECTION		TITLE:	
1. General	√	ANGLE	±2°	DATE	2025.3.4	Pitch: 2.54*H2.50mm Pin Header Dual Row SMT Type	
2. Tape&Reel	√	X.XXX	±0.05	DRAWN	莫健勇	CUSTOMER:	N/A
3. Tube		X.XX	±0.25	CHECKED	郑双平	PART NO.:	QHD25IPC369
4. Tray		X.X	±0.35	APPROVED	冯显东	SCALE:	2:1
5. Other		X.	±0.50			UNIT:	mm
						SHEET:	1/1

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 GUANGDONG NATCONN ELECTRONIC CO.,LTD